

AMENDMENTS TO THE CLAIMS

The following listing of the claims replaces all previous versions of the claims presented in the application.

1. (Currently amended) A composition comprising:

i) a fragrance composition comprising

- a) at least 10.0% by weight of a fragrance composition of one or more perfume ingredients having a boiling point of 250°C or less and ClogP of less than 3.0;
- b) at least 15% by weight of a fragrance composition of one or more perfume ingredients having a boiling point of 250°C or less and ClogP of 3.0 or more; and
- c) at least 20% by weight of a fragrance composition of one or more perfume ingredients have a boiling point of greater than 250°C; and

ii) a non-ionic silicone-in-water emulsion comprising a linear polysiloxane polysilalkylene copolymer, wherein the monovalent silicone substituents are substantially all C₁₋₆ hydrocarbon groups and at least one surfactant, wherein the dispersed silicone copolymer is substantially linear, ~~has and has~~ a viscosity of 150 million mm²s⁻¹ or more and a particle size of 1 μm or less ~~a viscosity of 100 million mm²s⁻¹ or more and a particle size of 2 μm or less.~~

2. (Cancelled)

3. (Currently amended) The composition of claim 1 ~~claim 2~~, wherein the silicone-in-water emulsion is a non-ionic emulsion comprising about 60 % by weight of a linear silicone copolymer formed by the hydrosilylation of a Si-H end-blocked polydimethyl siloxane and a vinyl-end-blocked polydimethyl siloxane, wherein the copolymer has a viscosity of about 170 million mm²s⁻¹ and a particle size of about 0.5 μm, and about 5 % by weight of non-ionic surfactants.

4. (Previously presented) The composition of claim 1, wherein said fragrance composition comprises:

a) at least 10.0% by weight of a fragrance composition of one or more perfume ingredients having a boiling point of 250 °C or less and ClogP of less than 3.0,

b) at least 20% by weight of a fragrance composition of one or more perfume ingredients having a boiling point of 250 °C or less and ClogP of 3.0 or more, and

c) at least 30% by weight of a fragrance composition of one or more perfume ingredients have a boiling point of greater than 250 °C.

5. (Previously Presented) The composition of claim 1, wherein said fragrance composition comprises:

a) at least 20.0% by weight of the fragrance composition of one or more perfume ingredients having a boiling point of 250 °C or less and ClogP of less than 3.0;

b) at least 15% by weight of the fragrance composition of one or more perfume ingredients having a boiling point of 250 °C or less and ClogP of 3.0 or more; and

c) at least 30% by weight of the fragrance composition of one or more perfume ingredients have a boiling point of greater than 250 °C.

6. (Previously Presented) The composition of claim 1, wherein said fragrance composition comprises:

a) 30.0 to 40.0 % by weight of the fragrance composition of one or more perfume ingredients having a boiling point of 250 °C or less and ClogP of less than 3.0;

b) 20.0 to 25.0 % by weight of the fragrance composition of a one or more perfume ingredients having a boiling point of 250 °C or less and ClogP of 3.0 or more; and

c) 40.0 to 45.0 % by weight of the fragrance composition of one or more perfume ingredients have a boiling point of greater than 250 °C.

7. (Previously Presented) The composition of claim 1, wherein the silicone:fragrance composition weight ratio is from 1:1 to 10:1.

8. (Previously Presented) A hair care preparation comprising a composition according to claim 1.

9. (Original) The hair care preparation of claim 8, wherein the hair care preparation is a shampoo, a conditioner, or a conditioning shampoo.

10. (Previously Presented) A method of cleansing hair, which comprises applying to the hair a hair care preparation according to claim 8.

11. (Previously Presented) A method of depositing fragrance on hair, which comprises applying to the hair a hair care preparation according to claim 8.